3GPP TSG SA WG 1 Meeting 97e S1-22xxxx

Electronic Meeting, 14 –24 February 2022

**Title: Draft LS Response on Haptics**

**Response to: LS <** **S1-220173 > on <** **Liaison to 3GPP SA1 on Haptics > from <** **ISO/IEC JTC 1/SC 29/WG 2 N00172 >**

**Release: Rel-18**

**Work Item: -**

**Source: SA1**

**To: ISO/IEC JTC 1/SC 29/WG 2 N00172**

**Cc:**

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**Send any reply LS to: 3GPP Liaisons Coordinator,** [**mailto:3GPPLiaison@etsi.org**](mailto:3GPPLiaison@etsi.org)

**Attachments:** TS 22.261 v18.5.0, TS22.104 v18.3.0

# 1 Overall description

SA1 thanks ISO/IEC JTC 1/SC 29/WG 2 N00172 for LS on Haptics.

About 3GPP TS documents that would include additional information regarding haptics, please review the following TS if necessary:

* TS 22.261 contains the output from TR22.847 about latency requirements for haptic information in chapter 6.43 and 7.11;
* TS 22.104 contains haptic requirements in chapter 5.2 Periodic deterministic communication, and also in A.6.2, A.6.3.

# 2 Actions

**To ISO/IEC JTC 1/SC 29/WG 2 N00172**

**ACTION:** SA1 kindly ask ISO/IEC JTC 1/SC 29/WG 2 N00172 to take the above into consideration

# 3 Dates of next TSG SA WG 1 meetings

SA1#98e 09-19 May 2022 Electronic Meeting

SA1#99 22-26 Aug 2022 Goteborg, Sweden or Electronic Meeting